



## SMT GaAs HBT MMIC x8 ACTIVE FREQUENCY MULTIPLIER, 9.9 - 11.2 GHz OUTPUT

### Typical Applications

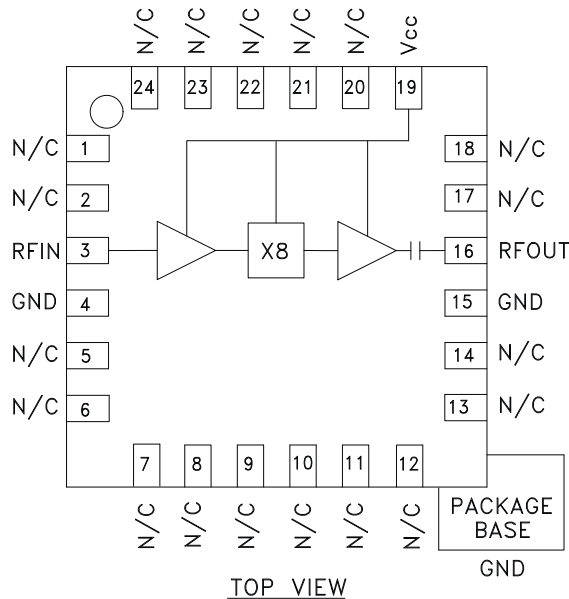
Active Multiplier for X Band Applications:

- Fiber Optic
- Point-to-Point Radios
- Military Radar

### Features

Output Power: +6 dBm  
Sub-Harmonic Suppression: >25 dBc  
SSB Phase Noise: -136 dBc/Hz  
Single Supply: +5V @ 68 mA  
24 Lead 4x4 mm SMT Package: 16 mm<sup>2</sup>

### Functional Diagram

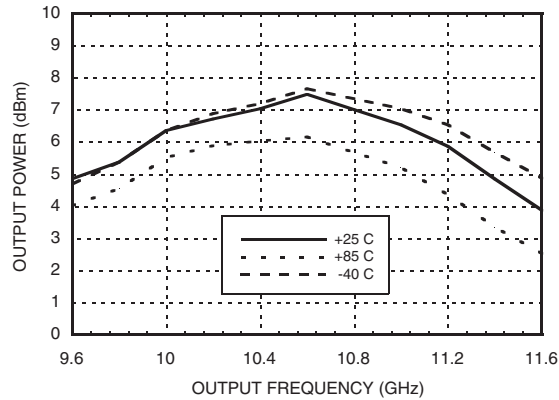
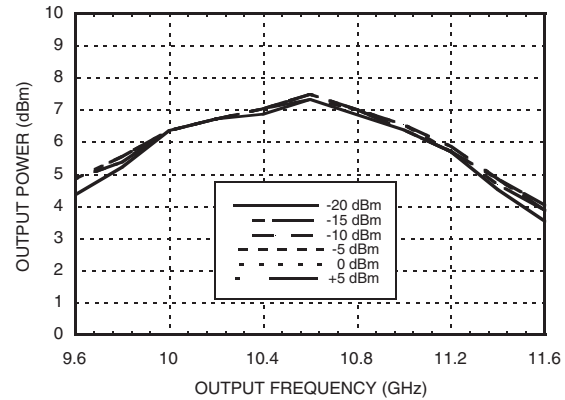
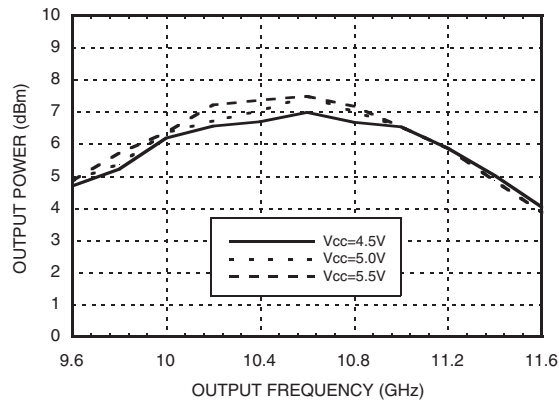
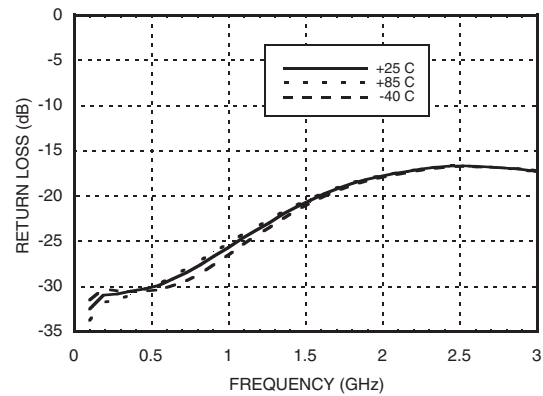
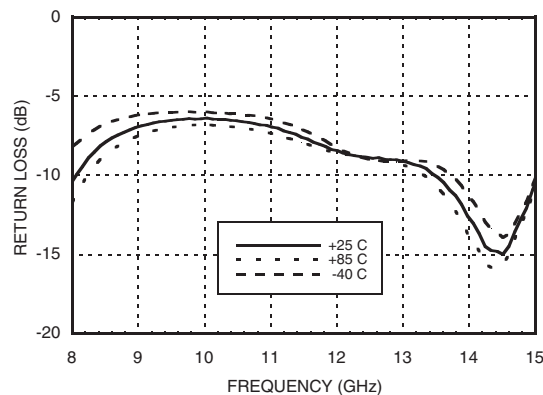


### General Description

The HMC444LP4 & HMC444LP4E are active miniature x8 frequency multipliers utilizing InGaP GaAs HBT technology in 4x4 mm leadless surface mount packages. Power output is +6 dBm typical from a 5V supply voltage and varies little vs. input power, temperature and supply voltage. Suppression of undesired fundamental and sub-harmonics is >25 dBc typical with respect to output signal level. The low additive SSB phase noise of -136 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance. The HMC444LP4 & HMC444LP4E are ideal for use in LO multiplier chains allowing reduced parts count vs. traditional approaches.

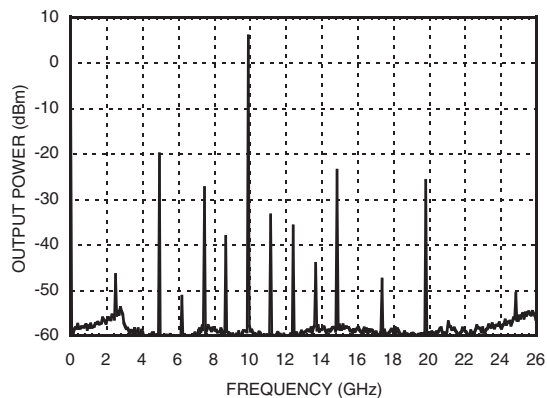
### Electrical Specifications, $T_A = +25^\circ \text{C}$ , $V_{CC} = 5V$

| Parameter                        | Min.          | Typ. | Max. | Units  |
|----------------------------------|---------------|------|------|--------|
| Frequency Range, Input           | 1.2375 - 1.40 |      |      | GHz    |
| Frequency Range, Output          | 9.9 - 11.2    |      |      | GHz    |
| Input Power Range                | -15           |      | +5   | dBm    |
| Output Power                     | 3             | 6    |      | dBm    |
| Sub-Harmonic Suppression         |               | 25   |      | dBc    |
| Input Return Loss                |               | 22   |      | dB     |
| Output Return Loss               |               | 7    |      | dB     |
| SSB Phase Noise (100 kHz Offset) | Pin = 0 dBm   |      |      | dBc/Hz |
| Supply Current (Icc)             |               | 68   | 91   | mA     |

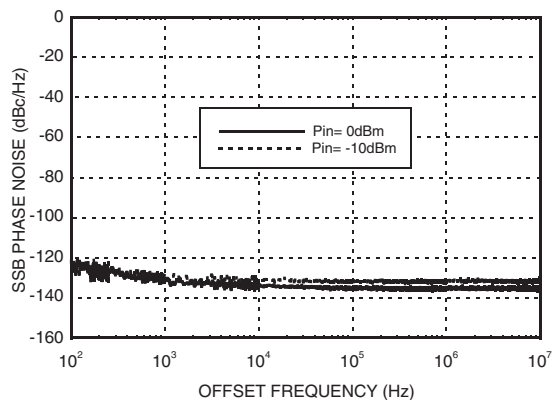

**SMT GaAs HBT MMIC x8 ACTIVE  
FREQUENCY MULTIPLIER, 9.9 - 11.2 GHz OUTPUT**
**Output Power vs.  
Temperature @ -10 dBm Drive Level**

**Output Power vs. Drive Level**

**Output Power vs.  
Supply Voltage @ -10 dBm Drive Level**

**Input Return Loss vs. Temperature**

**Output Return Loss vs. Temperature**


**SMT GaAs HBT MMIC x8 ACTIVE  
FREQUENCY MULTIPLIER, 9.9 - 11.2 GHz OUTPUT**

**Output Spectrum**



**SSB Phase Noise  
Performance,  $F_{out} = 10.5$  GHz**





## SMT GaAs HBT MMIC x8 ACTIVE FREQUENCY MULTIPLIER, 9.9 - 11.2 GHz OUTPUT

### Absolute Maximum Ratings

|   |                |
|---|----------------|
| RF Input (Vcc = +5V)  | +20 dBm        |
| Vcc   | +5.5V          |
| Channel Temperature   | 135 °C         |
| Continuous Pdiss (T=85 °C)<br>(derate 10 mW/°C above 85 °C)           | 650 mW         |
| Thermal Resistance (R <sub>thj</sub> )<br>(junction to ground paddle) | 100 °C/W       |
| Storage Temperature   | -65 to +150 °C |
| Operating Temperature   | -40 to +85 °C  |

### Typical Supply Current vs. Vcc

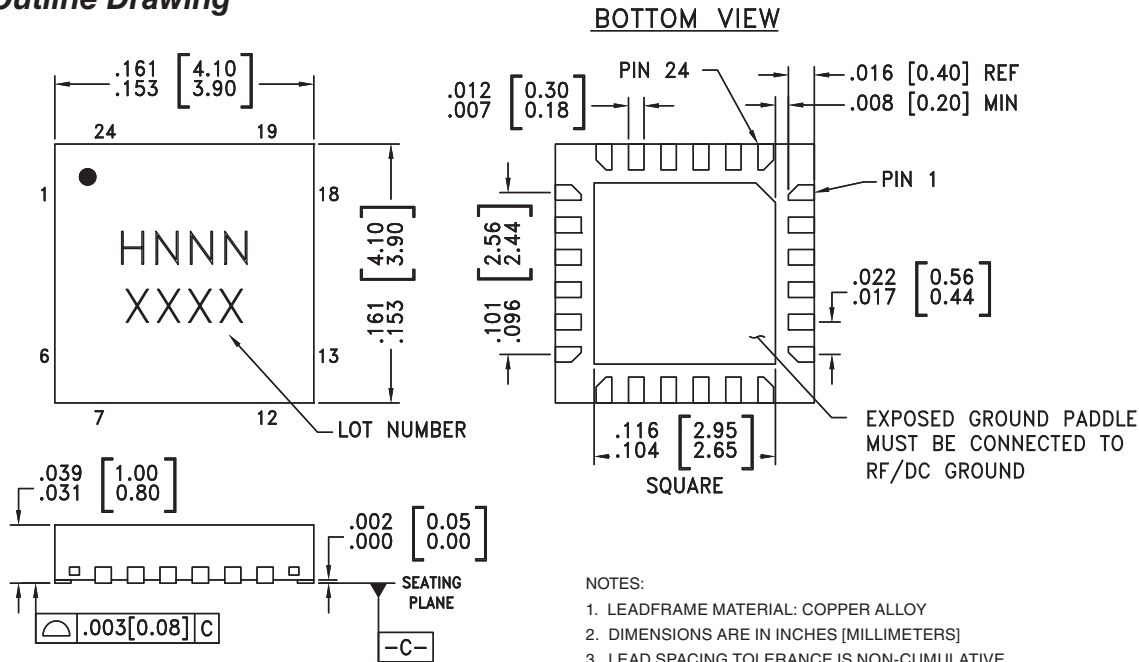
| Vcc (V) | Icc (mA) |
|---------|----------|
| 4.5     | 66       |
| 5.0     | 68       |
| 5.5     | 70       |

Note: Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



### Package Information

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating          | Package Marking <sup>[3]</sup> |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC444LP4   | Low Stress Injection Molded Plastic                | Sn/Pb Solder  | MSL1 <sup>[1]</sup> | H444<br>XXXX                   |
| HMC444LP4E  | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 <sup>[2]</sup> | H444<br>XXXX                   |

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

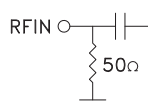


Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at [www.analog.com](http://www.analog.com) Application Support: Phone: 1-800-ANALOG-D

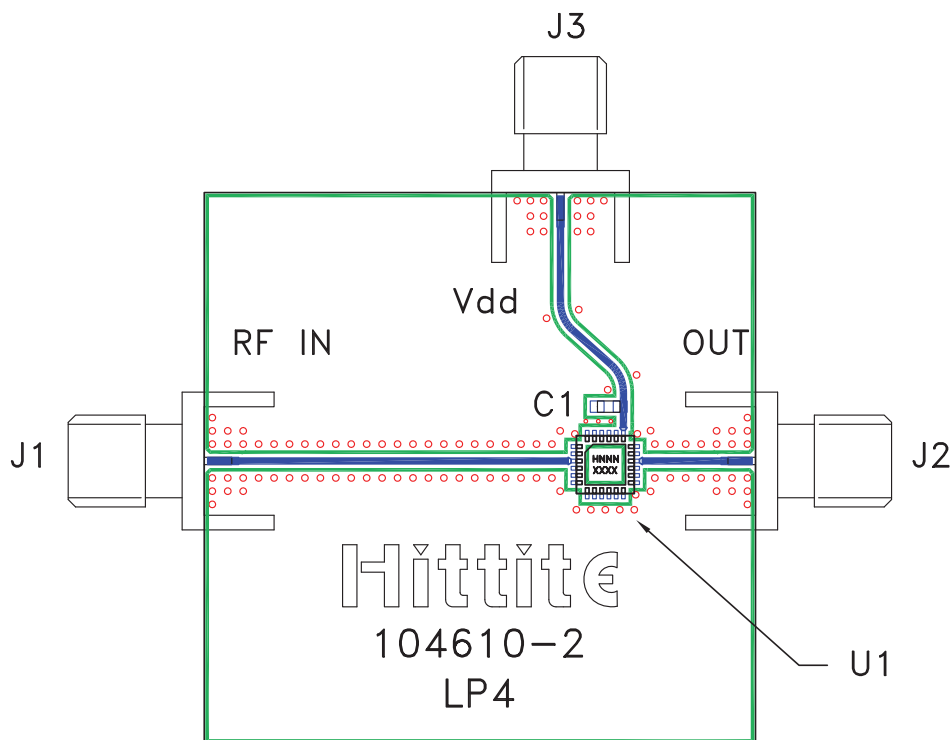


**SMT GaAs HBT MMIC x8 ACTIVE  
FREQUENCY MULTIPLIER, 9.9 - 11.2 GHz OUTPUT**

**Pin Description**

| Pin Number                       | Function | Description  | Interface Schematic   |
|----------------------------------|----------|--|---|
| 1, 2, 5 - 14,<br>17, 18, 20 - 24 | N/C      | The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally. |   |
| 3                                | RFIN     | RF input needs to be DC blocked only if there is an external DC voltage applied to RF IN.  |  |
| 4, 15                            | GND      | All ground leads and ground paddle must be soldered to PCB RF/DC ground.   |  |
| 16                               | RFOUT    | Multiplied Output. AC coupled. No external DC blocks necessary.  |  |
| 19                               | Vcc      | Supply voltage 5V ± 0.5V.  |   |

**Evaluation PCB**



**List of Materials for Evaluation PCB 106137 [1]**

| Item    | Description                       |
|---------|-----------------------------------|
| J1 - J3 | PCB Mount SMA Connector           |
| C1      | 1,000 pF Capacitor, 0603 Pkg.     |
| U1      | HMC444LP4(E) x8 Active Multiplier |
| PCB [2] | 104610 Eval Board                 |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.